

RoHS Compliant Product  
A suffix of "-C" specifies halogen free

## DESCRIPTION

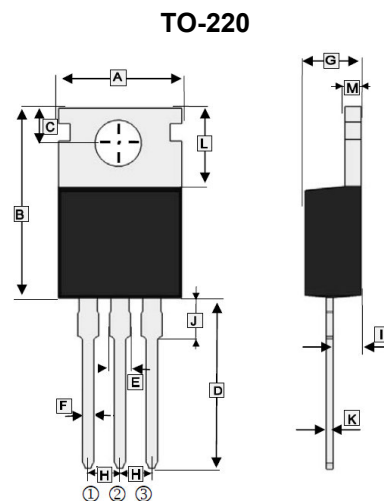
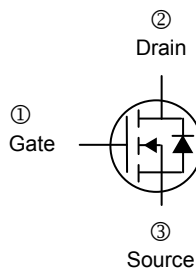
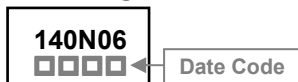
The SSE140N06-C is the highest performance trench N-Ch MOSFETs with extreme high cell density, which provide excellent  $R_{DS(ON)}$  and gate charge for most of the synchronous buck converter applications.

The SSE140N06-C meet the RoHS and Green Product requirement with full function reliability approved.

## FEATURES

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent dv/dt effect decline
- Green Device Available

## MARKING



REF.	Millimeter		REF.	Millimeter	
	Min.	Max.		Min.	Max.
A	9.70	10.60	H	2.54 TYP	
B	14.22	16.5	I	2.03	2.92
C	2.54	3.40	J	2.70	3.30
D	12.7	14.7	K	0.33	0.65
E	1.17	1.78	L	5.5	7
F	0.4	1.00	M	1.20	1.40
G	3.60	4.82			

## ORDER INFORMATION

Part Number	Type
SSE140N06-C	Lead (Pb)-free and Halogen-free

## ABSOLUTE MAXIMUM RATINGS ( $T_A=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	$V_{DS}$	60	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Continuous Drain Current <sup>1</sup> @ $V_{GS}=10\text{V}$	$T_C=25^\circ\text{C}$	140	A
	$T_C=100^\circ\text{C}$	100	
Pulsed Drain Current <sup>2</sup>	$I_{DM}$	280	A
Single Pulse Avalanche Energy <sup>4</sup>	$E_{AS}$	820	mJ
Single Pulse Avalanche Current	$I_{AS}$	40.5	A
Power Dissipation	$T_C=25^\circ\text{C}$ $P_D$	138.8	W
Operating Junction and Storage Temperature	$T_J, T_{STG}$	-55~150	$^\circ\text{C}$
<b>Thermal Resistance Rating</b>			
Thermal Resistance Junction-Ambient <sup>1</sup>	$R_{\theta JA}$	62	$^\circ\text{C} / \text{W}$
Thermal Resistance Junction-Case <sup>1</sup>	$R_{\theta JC}$	0.9	$^\circ\text{C} / \text{W}$

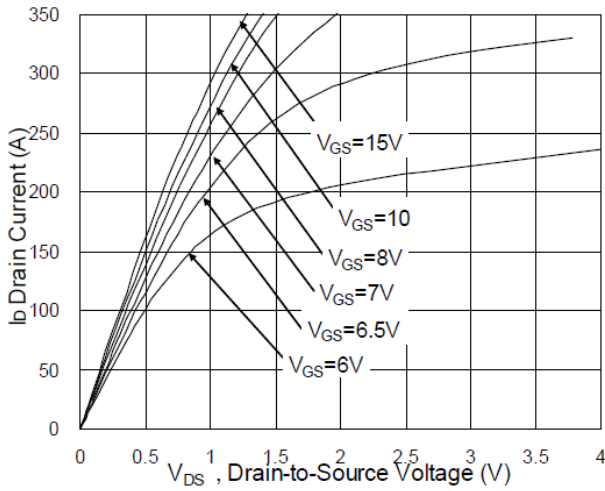
**ELECTRICAL CHARACTERISTICS** ( $T_J=25^\circ\text{C}$  unless otherwise specified)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	60	-	-	V	$V_{GS}=0V, I_D=250\mu A$
Gate-Threshold Voltage	$V_{GS(th)}$	2.5	-	4.5	V	$V_{DS}=V_{GS}, I_D=250\mu A$
Forward Transconductance	$g_{fs}$	-	50	-	S	$V_{DS}=5V, I_D=30A$
Gate-Source Leakage Current	$I_{GSS}$	-	-	$\pm 100$	nA	$V_{GS}=\pm 20V, V_{DS}=0V$
Drain-Source Leakage Current	$I_{DSS}$	-	-	1	$\mu A$	$V_{DS}=48V, V_{GS}=0V, T_J=25^\circ\text{C}$
		-	-	5		$V_{DS}=48V, V_{GS}=0V, T_J=55^\circ\text{C}$
Static Drain-Source On-Resistance <sup>3</sup>	$R_{DS(ON)}$	-	-	4.8	m $\Omega$	$V_{GS}=15V, I_D=30A$
		-	-	5		$V_{GS}=10V, I_D=20A$
Gate Resistance	$R_g$	-	1.4	-	$\Omega$	$V_{DS}=V_{GS}=0V, f=1\text{MHz}$
Total Gate Charge	$Q_g$	-	83.7	-	nC	$I_D=15A$ $V_{DS}=48V$ $V_{GS}=10V$
Gate-Source Charge	$Q_{gs}$	-	28.6	-		
Gate-Drain Charge	$Q_{gd}$	-	29.3	-		
Turn-on Delay Time	$T_{d(on)}$	-	38.1	-	nS	$V_{DD}=30V$ $I_D=30A$ $V_{GS}=10V$ $R_G=3.3\Omega$
Rise Time	$T_r$	-	73.3	-		
Turn-off Delay Time	$T_{d(off)}$	-	51.6	-		
Fall Time	$T_f$	-	26.1	-		
Input Capacitance	$C_{iss}$	-	5580	-	pF	$V_{GS}=0V$ $V_{DS}=15V$ $f=1\text{MHz}$
Output Capacitance	$C_{oss}$	-	571	-		
Reverse Transfer Capacitance	$C_{rss}$	-	278	-		
<b>Guaranteed Avalanche Characteristics</b>						
Single Pulse Avalanche Energy <sup>5</sup>	$E_{AS}$	312.5	-	-	mJ	$V_{DD}=30V, L=1\text{mH}, I_{AS}=25A$
<b>Source-Drain Diode</b>						
Diode Forward Voltage <sup>3</sup>	$V_{SD}$	-	-	1.2	V	$I_S=1A, V_{GS}=0V$
Reverse Recovery Time	$T_{rr}$	-	27	-	ns	$I_F=30A, di_F/dt=100A/\mu s$
Reverse Recovery Charge	$Q_{rr}$	-	28	-	nC	

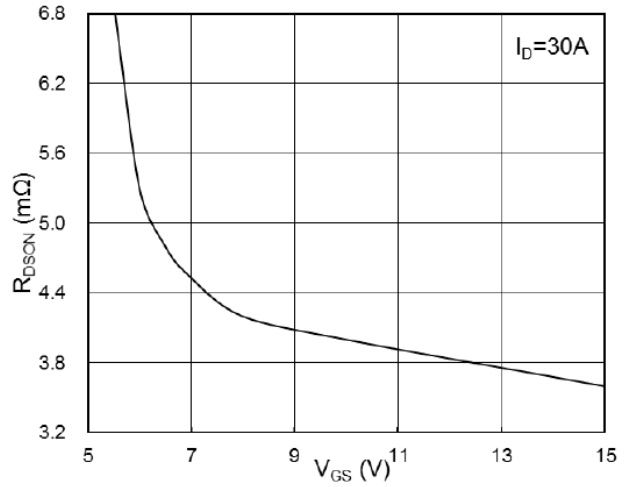
Notes:

1. The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.
2. The Pulse width limited by maximum junction temperature, Pulse Width  $\leq 10\mu s$ , Duty Cycle  $\leq 2\%$ .
3. The Pulse Test: Pulse Width  $\leq 300\mu s$ , Duty Cycle  $\leq 2\%$ .
4. The EAS data shows Max. rating. The test condition is  $V_{DD}=30V, V_{GS}=10V, L=1\text{mH}, I_{AS}=40.5A$
5. The Min. value is 100% EAS tested guarantee.

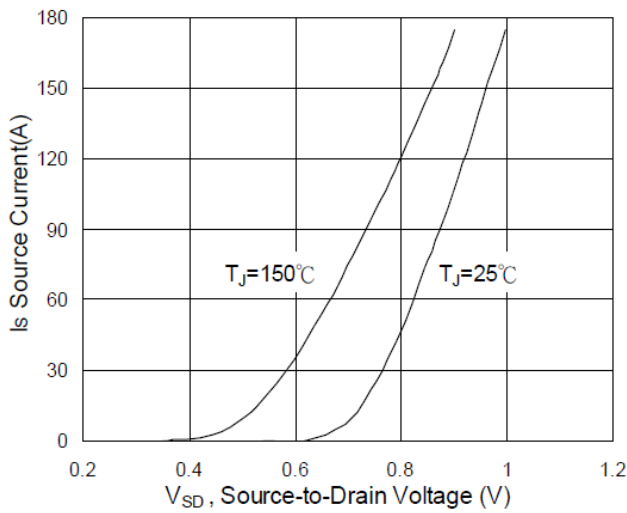
**CHARACTERISTIC CURVES**



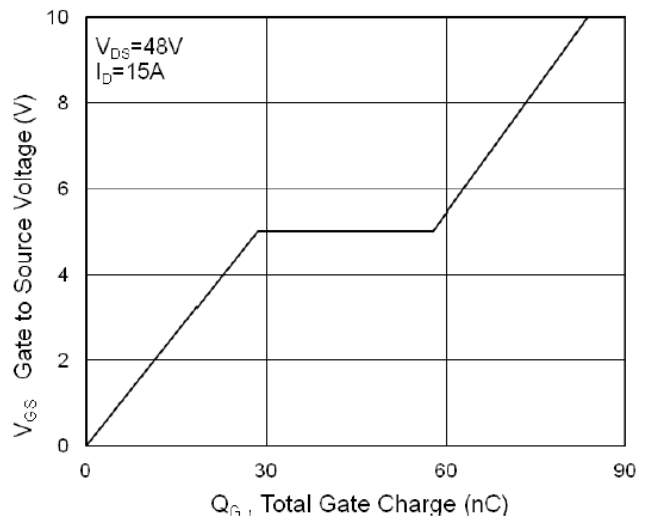
**Fig.1 Typical Output Characteristics**



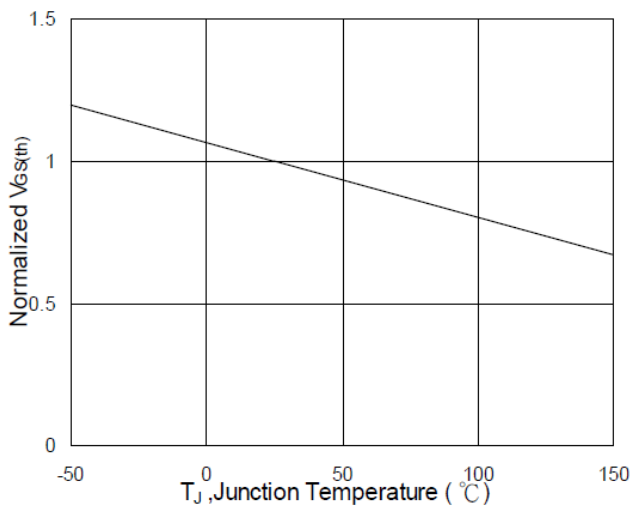
**Fig.2 On-Resistance vs. G-S Voltage**



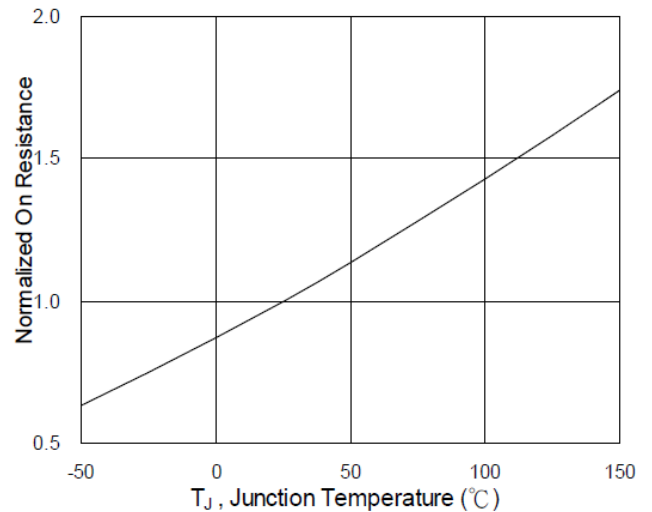
**Fig.3 Source Drain Forward Characteristics**



**Fig.4 Gate-Charge Characteristics**

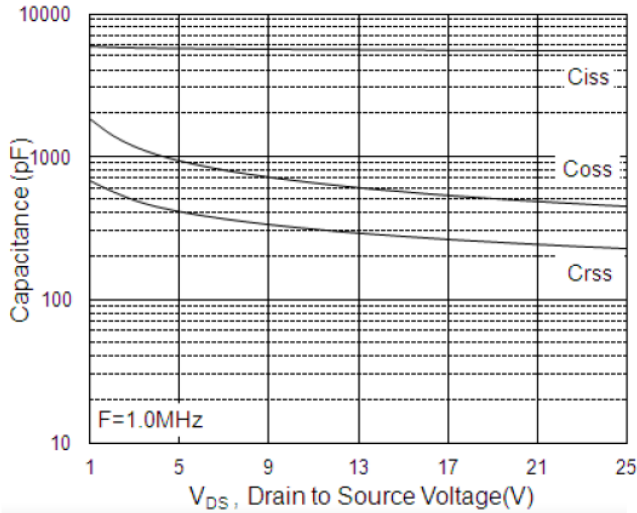


**Fig.5 Normalized  $V_{GS(th)}$  vs.  $T_J$**

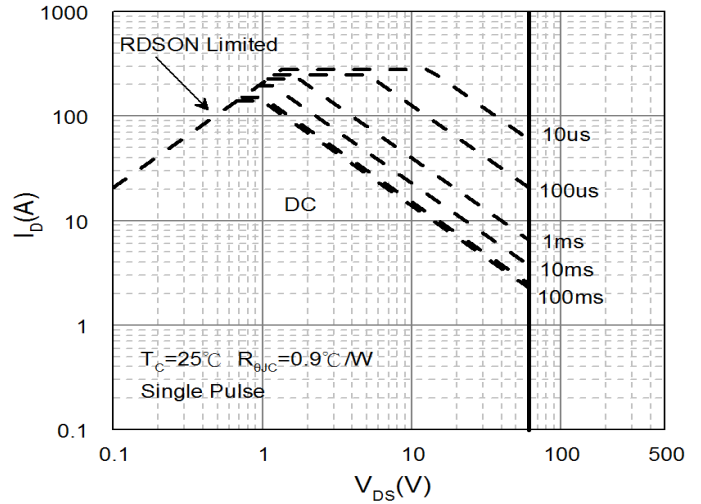


**Fig.6 Normalized  $R_{DS(on)}$  vs.  $T_J$**

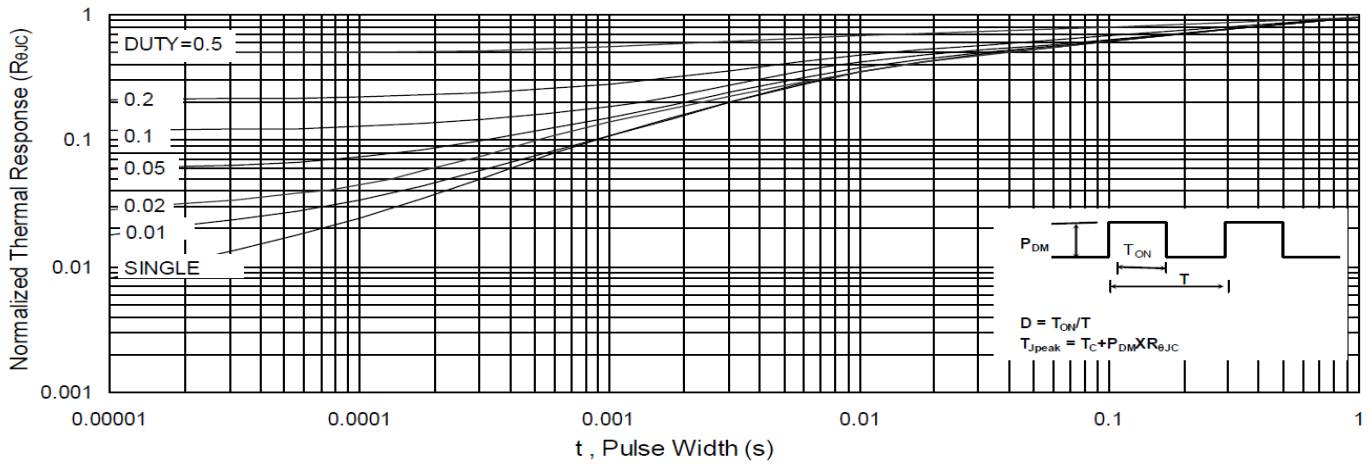
**CHARACTERISTIC CURVES**



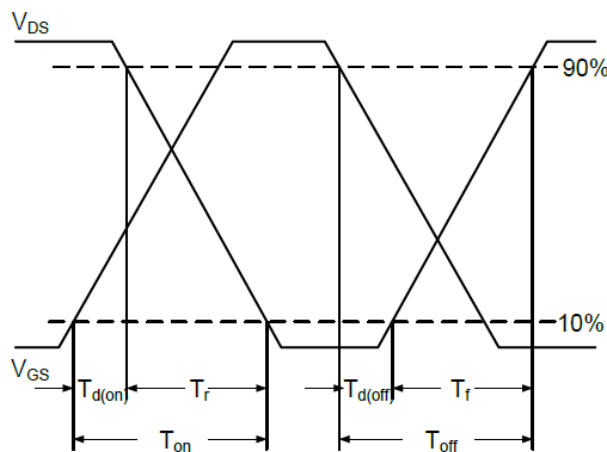
**Fig.7 Capacitance**



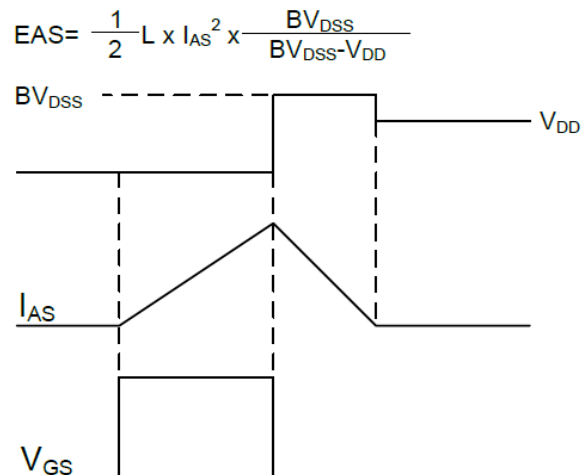
**Fig.8 Safe Operating Area**



**Fig.9 Normalized Maximum Transient Thermal Impedance**



**Fig.10 Switching Time Waveform**



**Fig.11 Unclamped Inductive Switching Waveform**